# **MA3X715** (MA715)

### Silicon epitaxial planar type

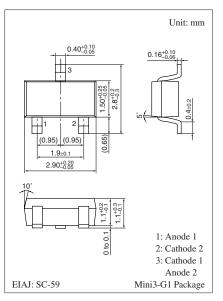
For high frequency rectification

#### ■ Features

- Low forward voltage V<sub>F</sub>
- Optimum for high frequency rectification because of its short reverse recovery time t<sub>rr</sub>

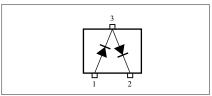
#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage		$V_R$	30	V
Maximum peak reverse voltage		$V_{RM}$	30	V
Forward current	Single	$I_F$	30	mA
	Series		20	
Peak forward	Single	$I_{FM}$	150	mA
current	Series		110	
Junction temperature		T <sub>j</sub>	125	°C
Storage temperature		$T_{stg}$	-55 to +125	°C



Marking Symbol: M2Y

#### Internal Connection

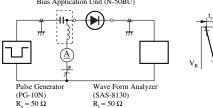


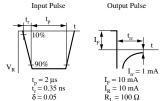
#### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{F1}$	$I_F = 1 \text{ mA}$			0.3	V
	$V_{F2}$	$I_F = 30 \text{ mA}$			1.0	
Reverse current	$I_R$	$V_R = 30 \text{ V}$			30	μΑ
Terminal capacitance	C <sub>t</sub>	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$ $I_{rr} = 1 \text{ mA}, R_I = 100 \Omega$		1.0		ns
Detection efficiency	η	$V_{IN} = 3 V_{(peak)}, f = 30 MHz$ $R_L = 3.9 k\Omega, C_L = 10 pF$		65		%

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 2 GHz.

4. \*: t<sub>rr</sub> measurement circuit
Input Pulse Output Puls

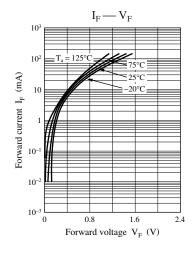


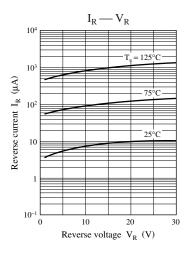


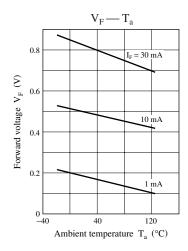
Note) The part number in the parenthesis shows conventional part number.

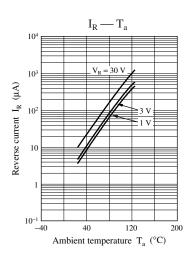
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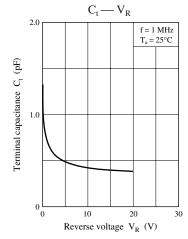
### **Panasonic**

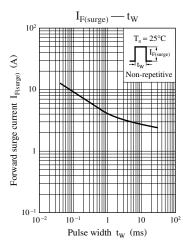












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